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Dated: September 6, 2001

Signature: William Smith

(William Smith)

Docket No.: TESSERA 30188 DE  
(PATENT)

SEP 14 2001

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

TECHNOLOGY CENTER 2800

Re Patent Application of:

Joseph Fjelstad

Application No.: 09/785,104

Group Art Unit: 2826

Filed: February 16, 2001

Examiner: K. Quinto

For: MICROELECTRONIC ELEMENTS WITH  
DEFORMABLE LEADS

Commissioner for Patents  
Washington, DC 20231

INFORMATION DISCLOSURE STATEMENT

Dear Sir:

It is respectfully requested that the reference listed on the enclosed form be made of record and considered with respect to the above-referenced U.S. patent application. A copy of the reference with English translation is enclosed. Submission of the present Information Disclosure Statement should not be taken as an admission that the cited references are legally available prior art or that the same are pertinent or material.

In the event that any fee is due in connection with the present Information Disclosure Statement, the Commissioner is hereby authorized to charge the same to our Deposit Account No. 12-1095.

Dated: September 6, 2001

Respectfully submitted,

By William Smith

William Smith

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